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MOS FIELD EFFECT POWER TRANSISTOR 2SK1850

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK1850 is N-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

Low On-state Resistance

$$\begin{split} R_{DS(on)} & \leq 70 \text{ } m\Omega \text{ } (\text{VGS} = 10 \text{ } \text{V, ID} = 5.0 \text{ A}) \\ R_{DS(on)} & \leq 95 \text{ } m\Omega \text{ } (\text{VGS} = 4 \text{ } \text{V, ID} = 5.0 \text{ A}) \end{split}$$

- Low C_{iss} C_{iss} = 1 200 pF TYP.
- Built-in G-S Gate Protection Diode

QUALITY GRADE

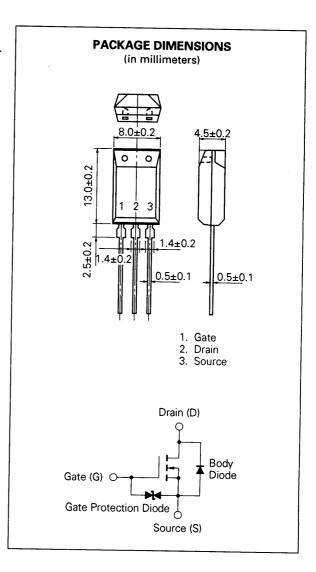
Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C)

Drain to Source Voltage	Voss	60	V
Gate to Source Voltage	VGSS(AC)	±20	٧
Gate to Source Voltage	VGSS(DC)	-20,–10	٧
Drain Current (DC)	ID(DC)	±10	Α
Drain Current (pulse)	D(pulse)*	±40	Α
Total Power Dissipation (Ta = 25 °C)	Рт	1.8	W
Channel Temperature	Tch	150	°C
Storage Temperature	T _{stg} -55	5 to +150	°C
# DIM < 10 40 District < 4.04	_		_

* PW \leq 10 μ s, Duty Cycle \leq 1 %

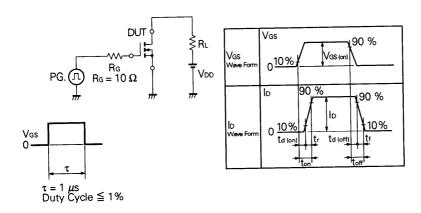




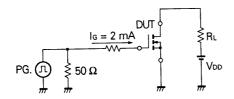
ELECTRICAL CHARACTERISTICS (Ta = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		55	70	mΩ	Vgs = 10 V, lp = 5 A
Drain to Source On-state Resistance	RDS(on)		80	95	mΩ	Vgs = 4 V, lp = 5 A
Gate to Source Cutoff Voltage	Vgs(off)	1.0		2.5	V	V _{D8} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y fs	5.5			S	V _D s = 10 V, I _D = 5 A
Drain Leakage Current	ID88			10	μΑ	V _D s = 60 V, V _G s = 0
Gate to Source Leakage Current	lgss			±10	μΑ	Vgs = ±20 V, Vps = 0
Input Capacitance	Ciss		1 200		pF	V _{DS} = 10 V V _{GS} = 0 f = 1 MHz
Output Capacitance	Coss		500		pF	
Reverse Transfer Capacitance	Сгвя		120		pF	
Turn-On Delay Time	td(on)		20		ns	$V_{GS(on)} = 10 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 5 \text{ A, Rg} = 10 \Omega$ $R_{L} = 6.0 \Omega$
Rise Time	tr		90		ns	
Turn-Off Delay Time	td(off)		250		ns	
Fall Time	tr		110		ns	
Total Gate Charge	QG		27		nC	V _{GS} = 10 V I _D = 10 A V _{DD} = 48 V
Gate to Source Charge	Qgs		2.5		nC	
Gate to Drain Charge	QgD		8.0		nC	
Diode Forward Voltage	VF(S-D)		1.0		V	Vgs = 0, lp = 10 A
Reverse Recovery Time	trr		110		ns	I _F = 10 A, V _{GS} = 0 di/dt = 50 A/μs
Reverse Recovery Charge	Qrr		150		nC	

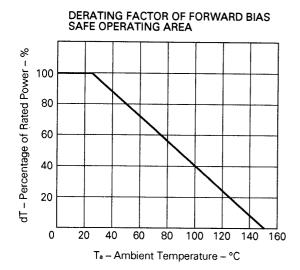
Test Circuit 1: Switching Time

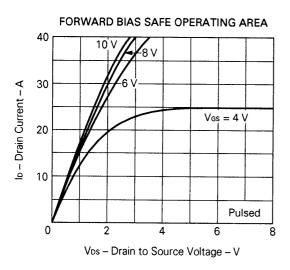


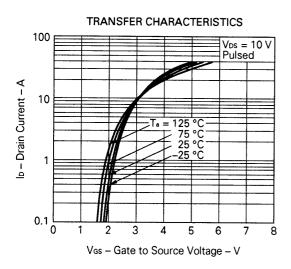
Test Circuit 2: Gate Charge

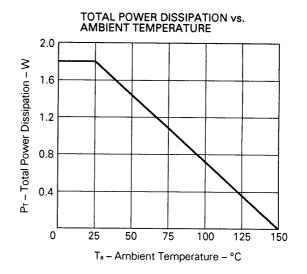


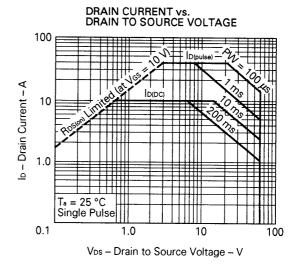
TYPICAL CHARACTERISTICS (Ta = 25 °C)



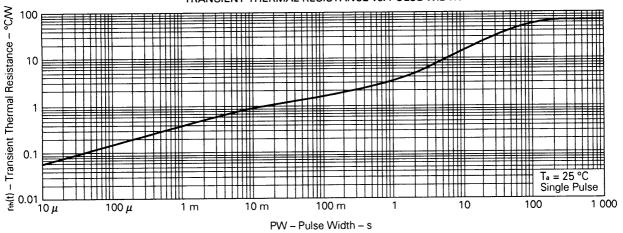




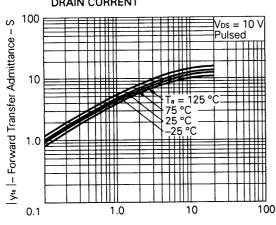




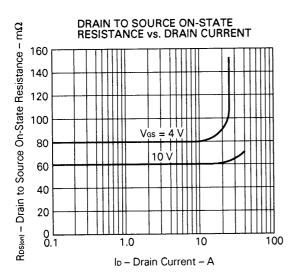




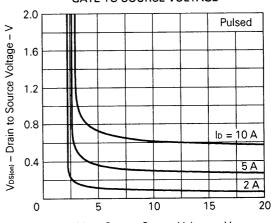
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



In - Drain Current - A

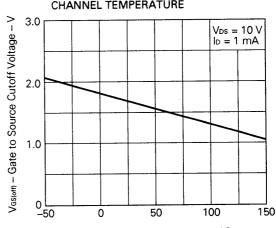


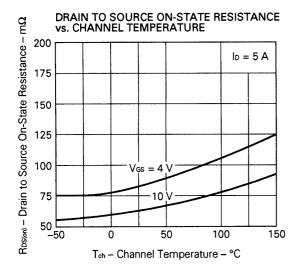
DRAIN TO SOURCE VOLTAGE vs. GATE TO SOURCE VOLTAGE

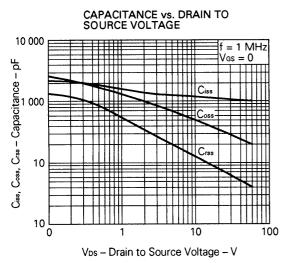


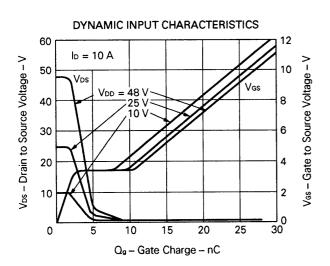
V_{GS} – Gate to Source Voltage – V

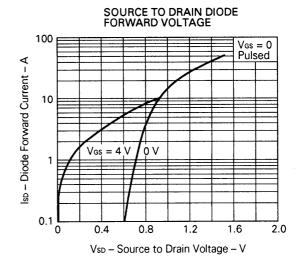
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

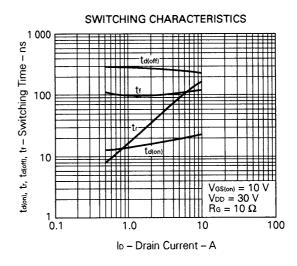


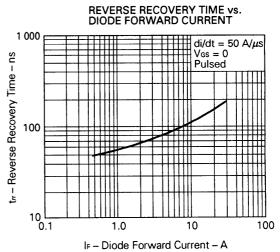












Reference

Application note name	No.
Safe operating area of Power MOS FET.	TEA-1034
Application circuit using Power MOS FET.	TEA-1035
Quality control of NEC semiconductors devices.	TEI-1202
Quality control guide of semiconductors devices.	MEI-1202
Assembly manual of semiconductors devices.	IEI-1207

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